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U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE

APPL NUM 10056054	FILING DATE 01/28/2002	CLASS 438	SUBCLASS 795	GAU 2812	EXAMINER Pham
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****APPLICANTS:** Yamazaki Shunpei; Ohnuma Hideto; Takano Tamae; Mitsuki Toru;

****CONTINUING DATA VERIFIED:**
NO

**** FOREIGN APPLICATIONS VERIFIED:**

JAPAN 2001-019331 01/29/2001
ye

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no Verified and Acknowledged Examiners's initials <i>ye</i>		ATTORNEY DOCKET NO 0756-2427
TITLE : Method for manufacturing a semiconductor device		

U.S. DEPT. OF COM. / PAT. & TM. PTO-436L (Rev. 12-54)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	(Print Claim for O.G.)
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drawg	Figs Drawg (Print Fig)
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	
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